IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bot international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
Supplie	r Information													
Company name*			Company un	Company unique ID			Unique ID Authority				Response Date*			
onsemi											2025-06-07			
Contact N	Jame	Title - Contact]	Phone - Contact*				Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorize	d Representative*	Title - Representative]	Phone - Representative*				Email - Representative*				
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	te Version Manufacturing Site			Weight*	UOM	Unit Type	
		FODM181AR2 4SO TR		4SO TR T&R	SO TR T&R		2025-06-07 EVERI		EVERLGFG	GFG 80.162		mg	Each	
Manufa	cturing Process Informa	ation												,
	Terminal Plating / Grid Array Material Terminal Bas			inal Base Alloy J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak			Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy			1			260		С	30	secon	ds 3			
Comments	3													
vel 1 - m	aximum time at peak tempera	ture during sol	dering is 10-3	0 seconds										
or more	information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale a											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	0.7885	mg	Supplier	Methylhydrogen Siloxane, Trimethylsiloxy-terminated	63148-57-2		0.0394	mg
			Supplier	Filler (SiO2)	68909-20-6		0.1183	mg
			Supplier	Dimethyl Siloxane	68083-19-2		0.6308	mg
Die	0.377	mg	Supplier	GaAs	1303-00-0		0.213	mg
			Supplier	Silicon (Si)	7440-21-3		0.164	mg
Die Attach	0.08	mg	Supplier	Silver (Ag)	7440-22-4		0.06	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.02	mg
Lead Frame	23.3895	mg	Supplier	Silver (Ag)	7440-22-4		0.0585	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2105	mg
			Supplier	Iron (Fe)	7439-89-6		0.4912	mg
			Supplier	Copper (Cu)	7440-50-8		22.4188	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2105	mg
Mold Compound-Black	35.7652	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		21.4591	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3577	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		10.7296	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.2189	mg
Mold Compound-White	19.6848	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.937	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		13.7794	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.9685	mg
Plating	0.002	mg	Supplier	Tin (Sn)	7440-31-5		0.002	mg
Wire Bond - Au	0.075	mg	Supplier	Gold (Au)	7440-57-5		0.075	mg